

ECH8656 — N-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- ON-resistance $R_{DS(on)1}=13m\Omega$ (typ.)
- Halogen free compliance
- Protection diode in
- 1.8V drive
- Nch + Nch MOSFET

Specifications

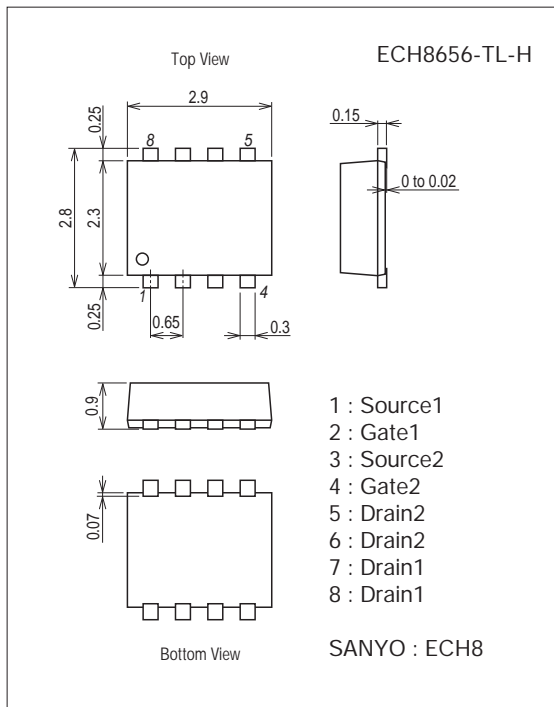
Absolute Maximum Ratings at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		20	V
Gate-to-Source Voltage	V_{GSS}		± 10	V
Drain Current (DC)	I_D		7.5	A
Drain Current (Pulse)	I_{DP}	$PW \leq 10\mu\text{s}$, duty cycle $\leq 1\%$	40	A
Allowable Power Dissipation	P_D	When mounted on ceramic substrate (900mm ² ×0.8mm) 1unit	1.3	W
Total Dissipation	P_T	When mounted on ceramic substrate (900mm ² ×0.8mm)	1.5	W
Channel Temperature	T_{ch}		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

Package Dimensions

unit : mm (typ)

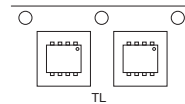
7011A-001



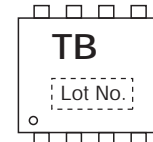
Product & Package Information

- Package : ECH8
- JEITA, JEDEC : -
- Minimum Packing Quantity : 3,000 pcs./reel

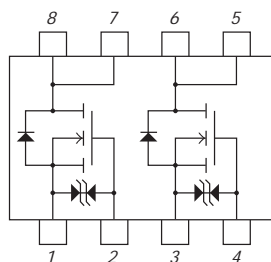
Packing Type : TL



Marking



Electrical Connection

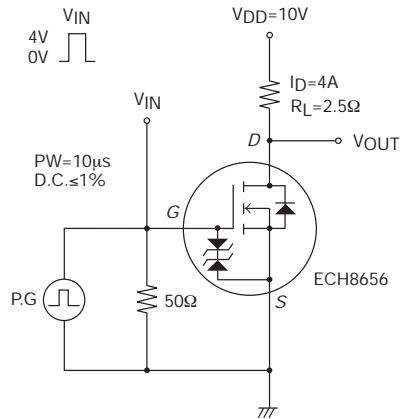


ECH8656

Electrical Characteristics at Ta=25°C

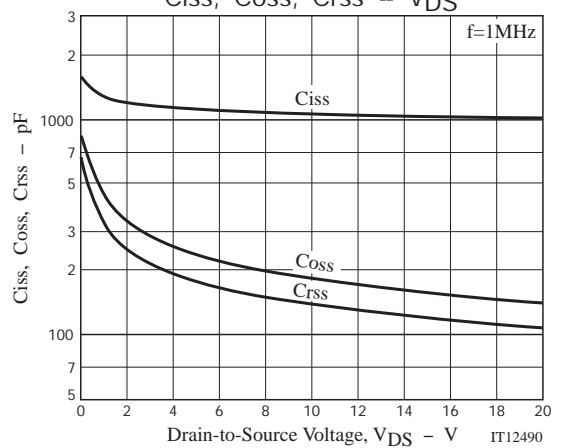
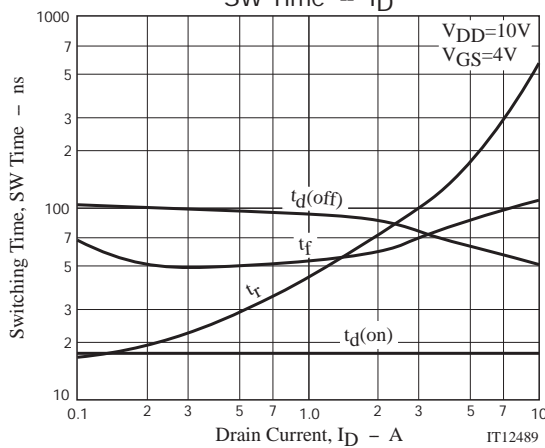
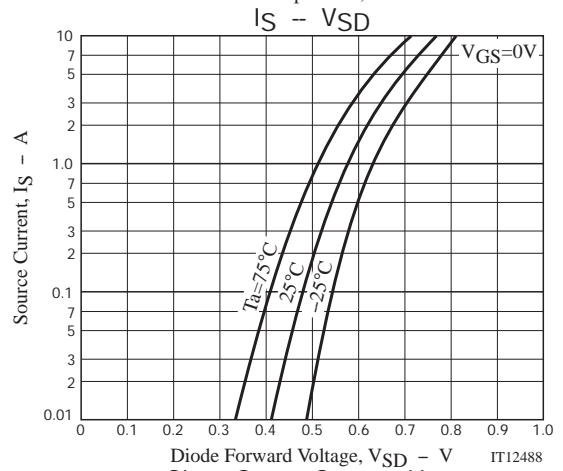
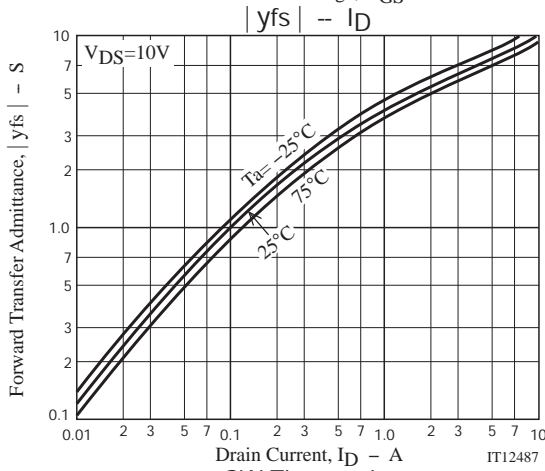
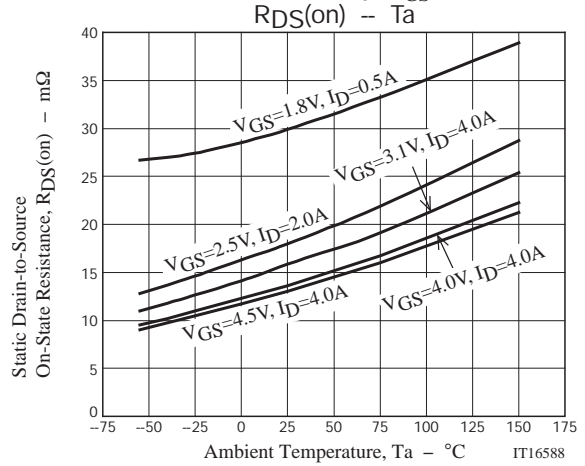
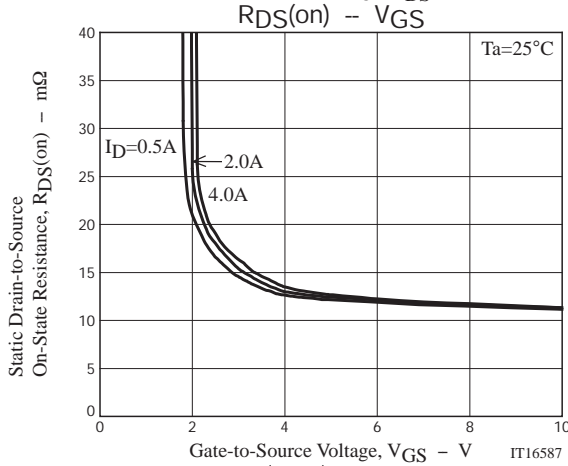
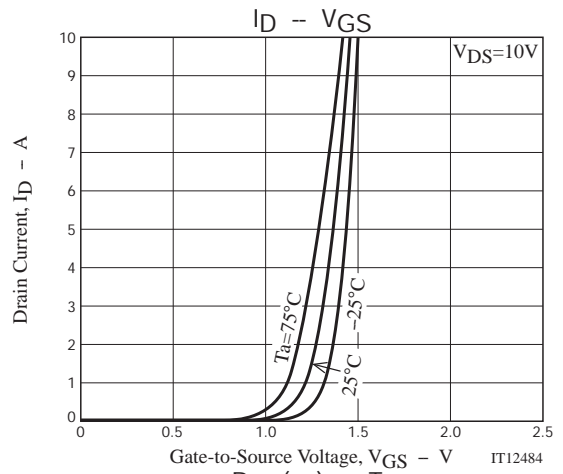
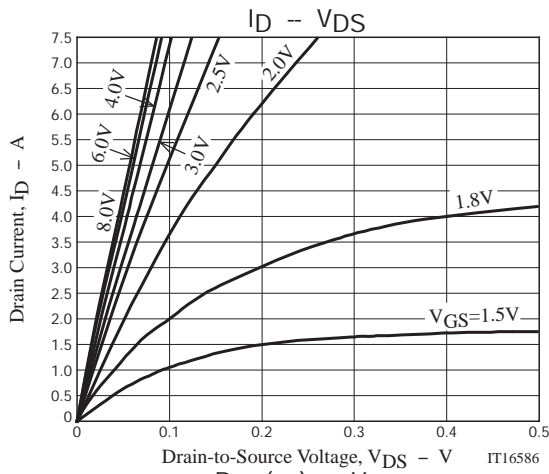
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0V$	20			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20V, V_{GS}=0V$			1	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 8V, V_{DS}=0V$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	0.5		1.3	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=4A$		7		S
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=4A, V_{GS}=4.5V$	9	13	17	$m\Omega$
	$R_{DS(on)2}$	$I_D=4A, V_{GS}=4.0V$	9.4	13.5	18	$m\Omega$
	$R_{DS(on)3}$	$I_D=4A, V_{GS}=3.1V$	11	16	22	$m\Omega$
	$R_{DS(on)4}$	$I_D=2A, V_{GS}=2.5V$	12.5	18	26	$m\Omega$
	$R_{DS(on)5}$	$I_D=0.5A, V_{GS}=1.8V$	17	30	48	$m\Omega$
Input Capacitance	C_{iss}	$V_{DS}=10V, f=1MHz$		1060		pF
Output Capacitance	C_{oss}			180		pF
Reverse Transfer Capacitance	C_{rss}			135		pF
Turn-ON Delay Time	$t_d(on)$			17.5		ns
Rise Time	t_r		See specified Test Circuit.		120	
Turn-OFF Delay Time	$t_d(off)$			68		ns
Fall Time	t_f			80		ns
Total Gate Charge	Q_g	$V_{DS}=10V, V_{GS}=4.5V, I_D=7.5A$		10.8		nC
Gate-to-Source Charge	Q_{gs}			2.1		nC
Gate-to-Drain "Miller" Charge	Q_{gd}			2.9		nC
Diode Forward Voltage	V_{SD}		$I_S=7.5A, V_{GS}=0V$		0.74	1.2

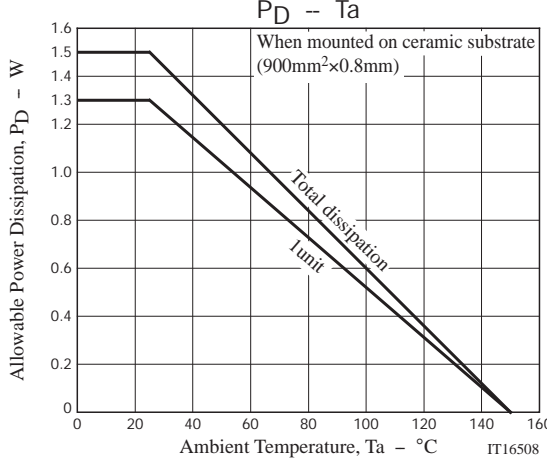
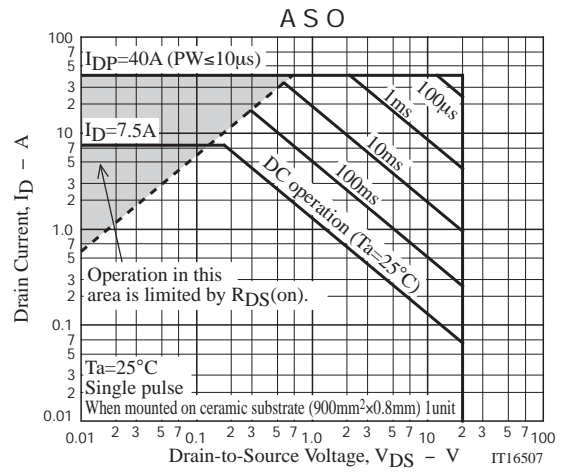
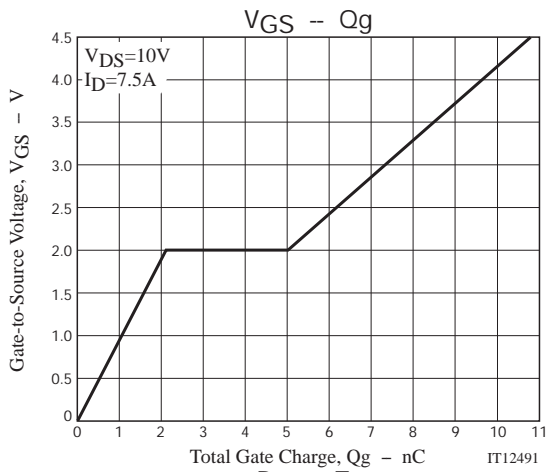
Switching Time Test Circuit



Ordering Information

Device	Package	Shipping	memo
ECH8656-TL-H	ECH8	3,000pcs./reel	Pb Free and Halogen Free





Embossed Taping Specification

ECH8656-TL-H

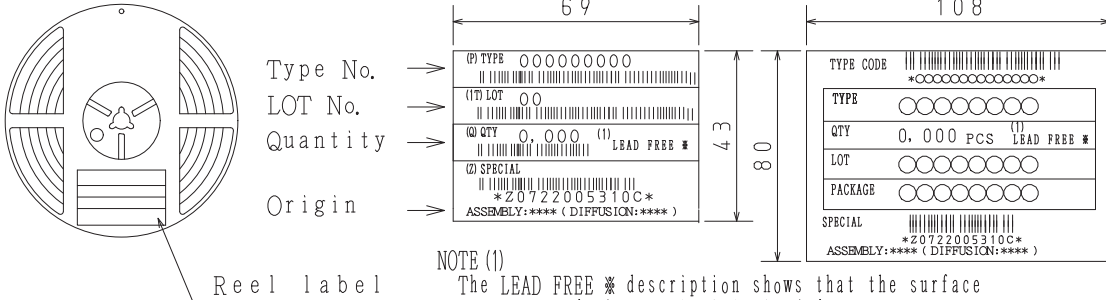
1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
ECH8	CPH6	3,000	15,000	90,000	5 reels contained Dimensions:mm (external) 183×72×185	6 inner boxes contained Dimensions:mm (external) 440×195×210

Packing method

Reel label, Inner box label (unit : mm) Outer box label

It is a label at the time of factory shipments.
The form of a label may change in physical distribution process.

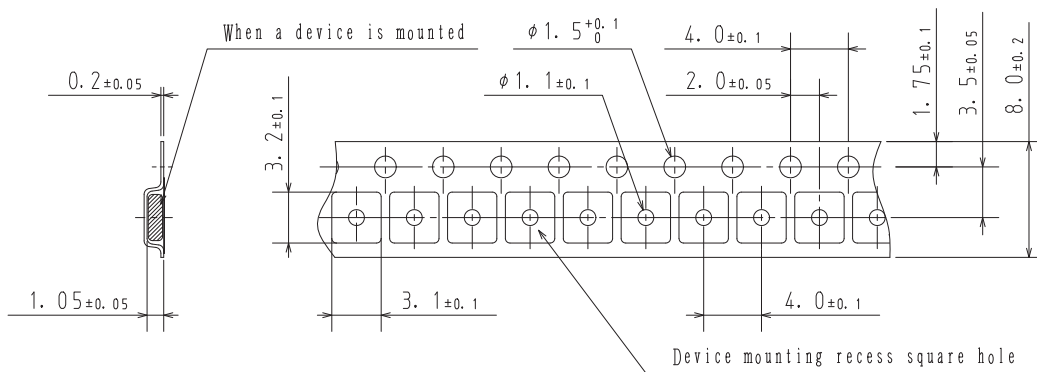


NOTE (1)
The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

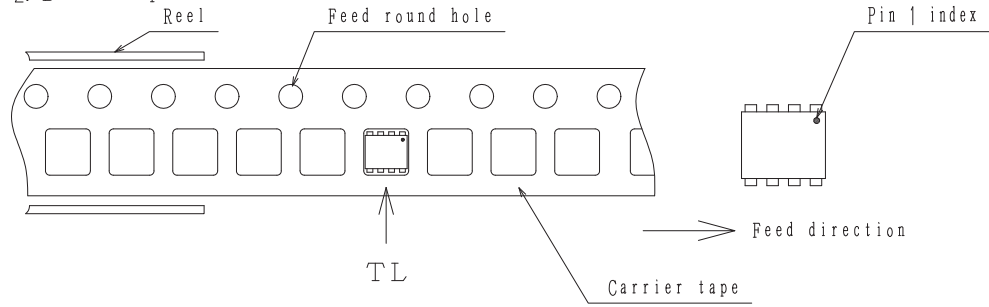
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



2-2. Device placement direction

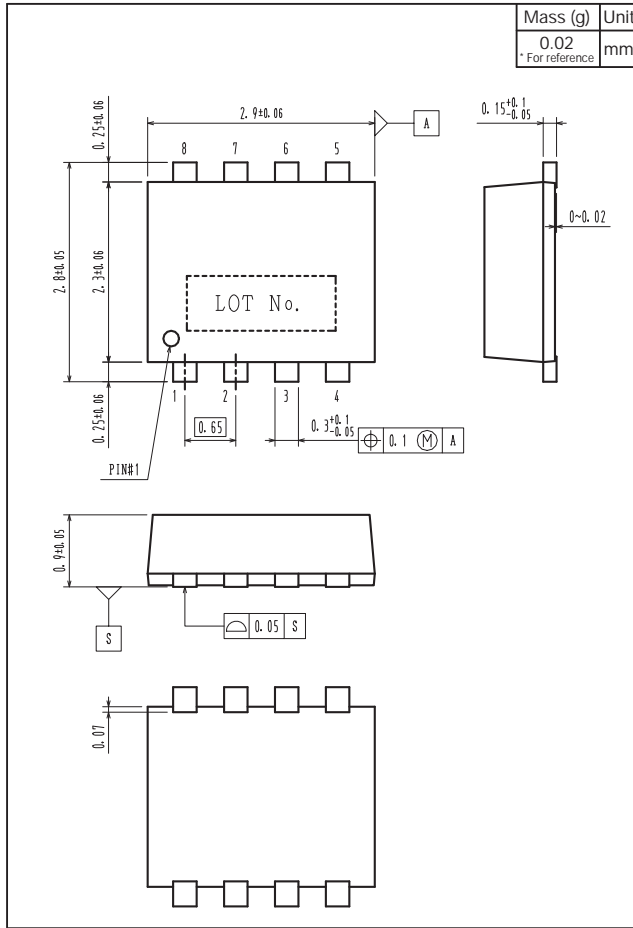


Those with pin 1 index on the feed hole side.....TL

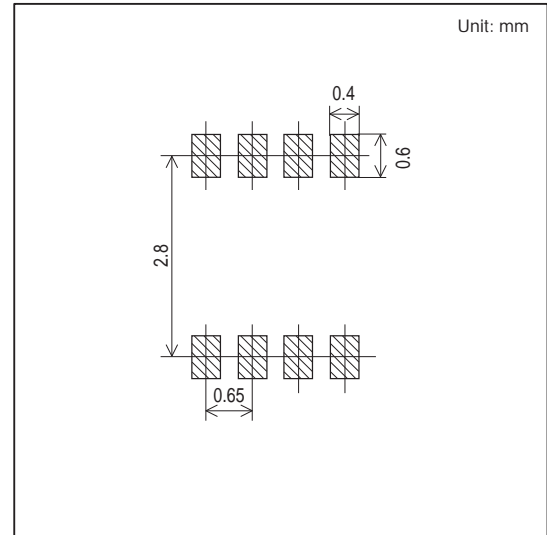
ECH8656

Outline Drawing

ECH8656-TL-H



Land Pattern Example



Note on usage : Since the ECH8656 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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